



## Emotion-Aware Intelligent Environments

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Deadline for manuscript  
submissions:

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### Message from the Guest Editors

Dear colleague,

Emotion-aware ambient intelligence extends the notion of intelligent environments to detecting, processing, and adapting intelligent environments to users' emotional state, exploiting theories from psychology and social sciences for the analysis of human emotional context. Considering emotions in the user context can improve the customization of services in IoT scenarios and help users to improve their emotional intelligence. However, emotion technologies are rarely addressed within Aml systems, and have been frequently ignored. We are organizing the conference Intelligent Environments 2020 (<https://blogs.upm.es/ie2020/>), and our idea would be to recommend extended versions of selected papers of the conference for this Special Issue, in addition to papers submitted by researchers.

Dr. Carlos A. Iglesias

Dr. Álvaro Carrera

*Guest Editors*





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## Message from the Editor-in-Chief

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